General purpose transistor (dual transistors)

AEC-Q101 Qualified

EMZ1FHA / UMZ1NFHA / IMZ1AFRA

Not Recommended for New Designs

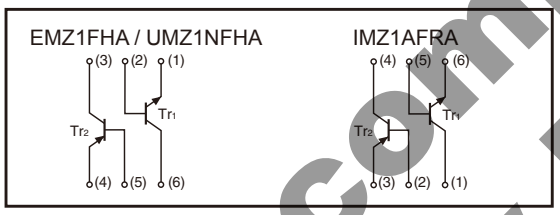
●Features

1) Both a 2SA1037AKFRA chip and 2SC2412KFRA chip in a EMT or UMT or SMT package.
2) Mounting possible with EMT3 or UMT3 or SMT3 automatic mounting machines.
3) Transistor elements are independent, eliminating interference.
4) Mounting cost and area can be cut in half.

●Structure

NPN / PNP epitaxial planar silicon transistor

●Equivalent circuit

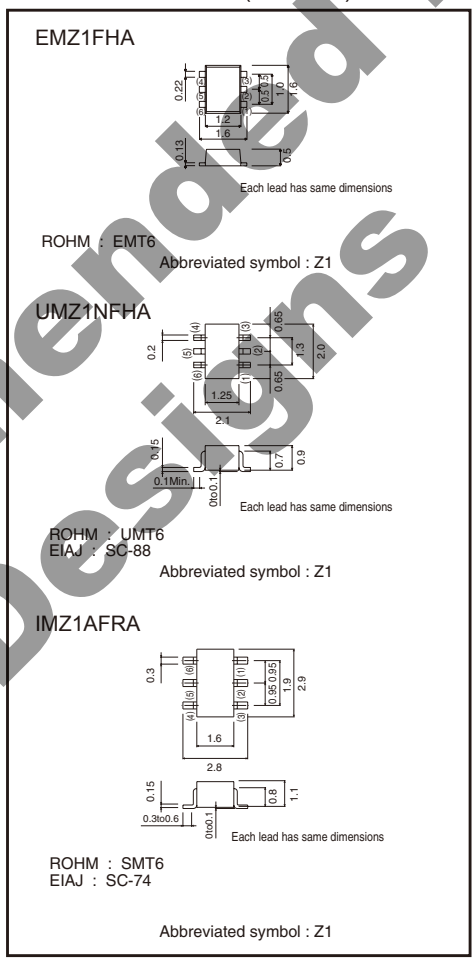


●Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits Tr1	Limits Tr2	Unit
Collector-base voltage		V_{CBO}	60	−60	V
Collector-emitter voltage		V_{CEO}	50	−50	V
Emitter-base voltage		V_{EBO}	7	−6	V
Collector current		I_C	150	−150	mA
Power dissipation	EMZ1FHA / UMZ1NFHA	P_C	150 (TOTAL)		mW *1
	IMZ1AFRA		300 (TOTAL)		mW *2
Junction temperature		Tj	150		˚C
Storage temperature		Tstg	−55 to +150		˚C

*1 120mW per element must not be exceeded.
*2 200mW per element must not be exceeded.

●External dimensions (Unit : mm)



●Electrical characteristics (Ta = 25°C)

Tr1 (NPN)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV_{CBO}	60	–	–	V	I_C=50μA
Collector-emitter breakdown voltage	BV_{CEO}	50	–	–	V	I_C=1mA
Emitter-base breakdown voltage	BV_{EBO}	7	–	–	V	I_E=50μA
Collector cutoff current	I_{CBO}	–	–	0.1	μA	V_{CB}=60V
Emitter cutoff current	I_{EBO}	–	–	0.1	μA	V_{EB}=7V
Collector-emitter saturation voltage	$V_{CE\ (sat)}$	–	–	0.4	V	I_C/I_B=50mA/5mA
DC current transfer ratio	h_{FE}	120	–	560	–	V_{CE}=6V, I_C=1mA
Transition frequency	f_T	–	180	–	MHz	V_{CE}=12V, I_E=–2mA, f=100MHz
Output capacitance	Cob	–	2	3.5	PF	V_{CB}=12V, I_E=0A, f=1MHz

Tr2 (PNP)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV_{CBO}	–60	–	–	V	I_C=–50μA
Collector-emitter breakdown voltage	BV_{CEO}	–50	–	–	V	I_C=–1mA
Emitter-base breakdown voltage	BV_{EBO}	–6	–	–	V	I_E=–50μA
Collector cutoff current	I_{CBO}	–	–	–0.1	μA	V_{CB}=–60V
Emitter cutoff current	I_{EBO}	–	–	–0.1	μA	V_{EB}=–6V
Collector-emitter saturation voltage	$V_{CE\ (sat)}$	–	–	–0.5	V	I_C/I_B=–50mA/–5mA
DC current transfer ratio	h_{FE}	120	–	560	–	V_{CE}=–6V, I_C=–1mA
Transition frequency	f_T	–	140	–	MHz	V_{CE}=–12V, I_E=2mA, f=100MHz
Output capacitance	Cob	–	4	5	PF	V_{CB}=–12V, I_E=0A, f=1MHz

●Packaging specifications

Type	Package	Taping		
	Code	T2R	TR	T108
	Basic ordering unit (pieces)	8000	3000	3000
EMZ1FHA		○	—	—
UMZ1NFHA		—	○	—
IMZ1AFRA		—	—	○

●Electrical characteristic curves

Tr1 (NPN)

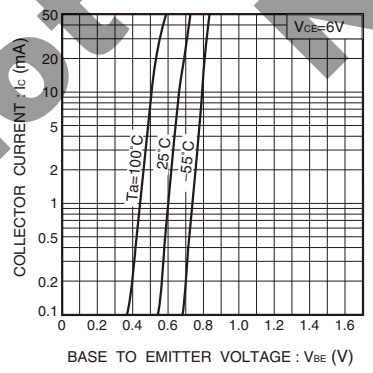


Fig.1 Grounded emitter propagation characteristics

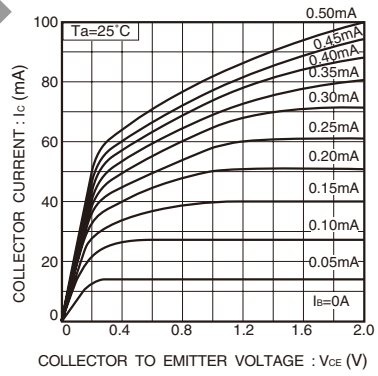


Fig.2 Grounded emitter output characteristics (I)

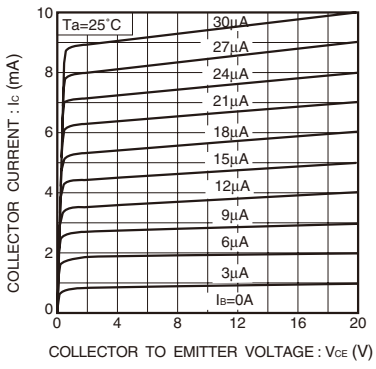


Fig.3 Grounded emitter output characteristics (II)

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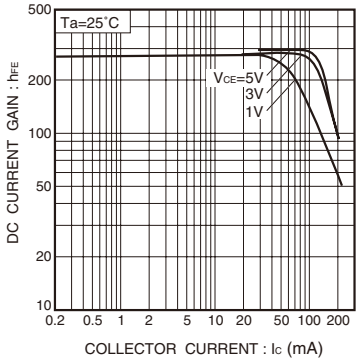

Fig.4 DC current gain vs. collector current (I)

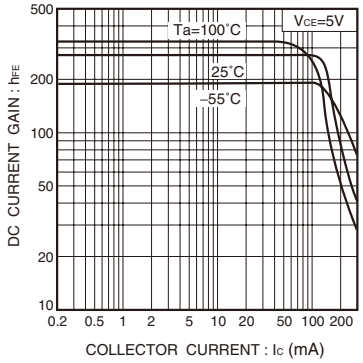

Fig.5 DC current gain vs. collector current (II)

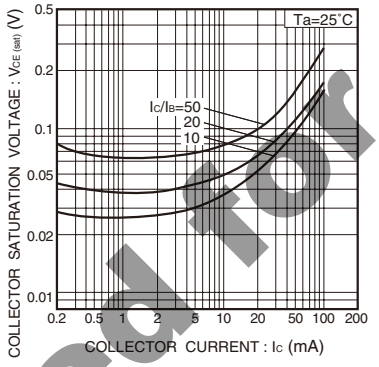

Fig.6 Collector-emitter saturation voltage vs. collector current (I)

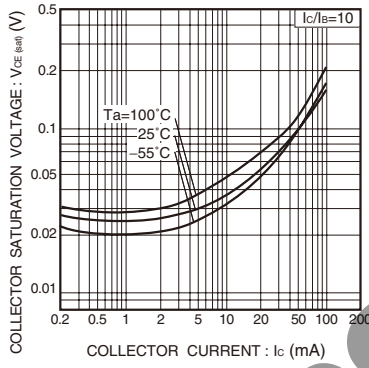

Fig.7 Collector-emitter saturation voltage vs. collector current (II)

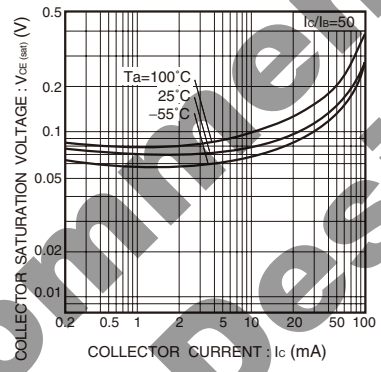

Fig.8 Collector-emitter saturation voltage vs. collector current (III)

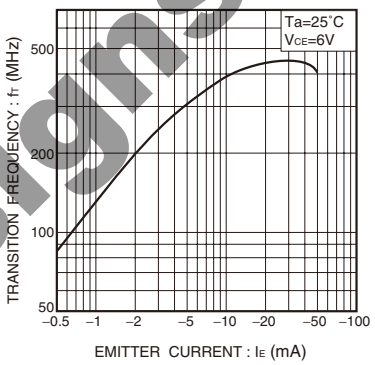

Fig.9 Gain bandwidth product vs. emitter current

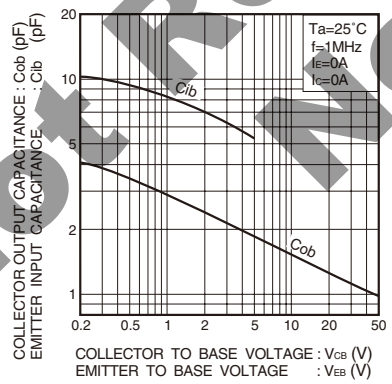

Fig.10 Collector output capacitance vs. collector-base voltage
Emitter input capacitance vs. emitter-base voltage

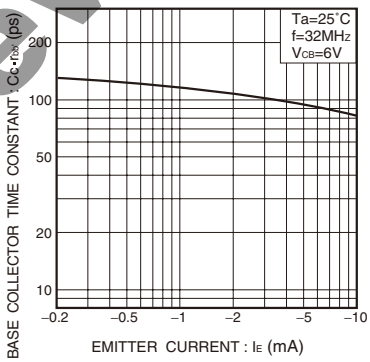

Fig.11 Base-collector time constant vs. emitter current

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Tr2 (PNP)

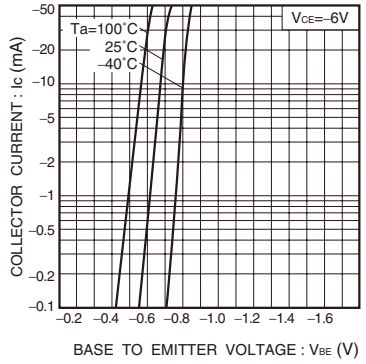

Fig.12 Grounded emitter propagation characteristics

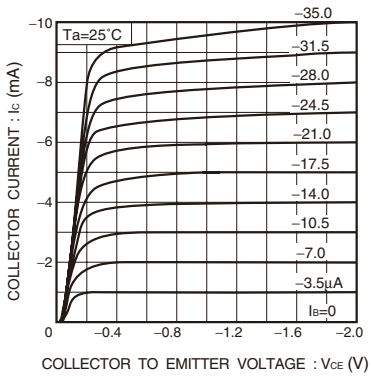

Fig.13 Grounded emitter output characteristics (I)

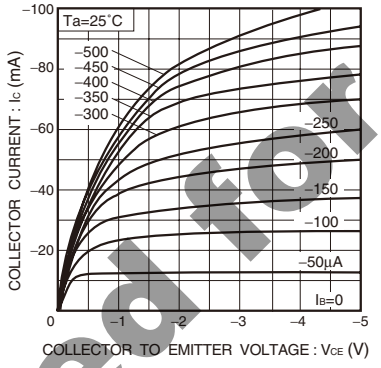

Fig.14 Grounded emitter output characteristics (II)

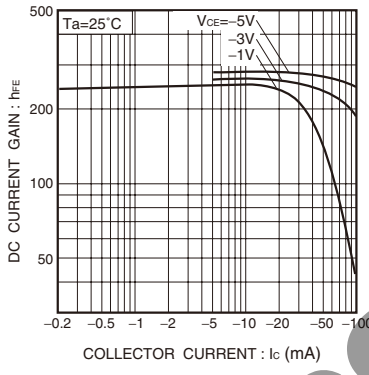

Fig.15 DC current gain vs. collector current (I)

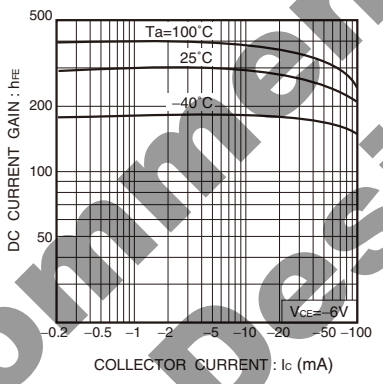

Fig.16 DC current gain vs. collector current (II)

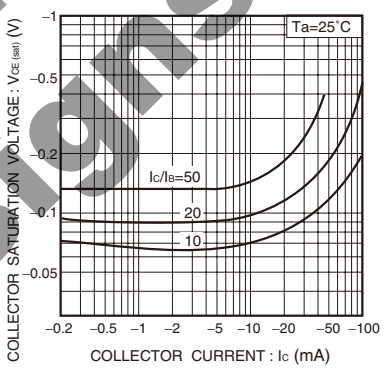

Fig.17 Collector-emitter saturation voltage vs. collector current (I)

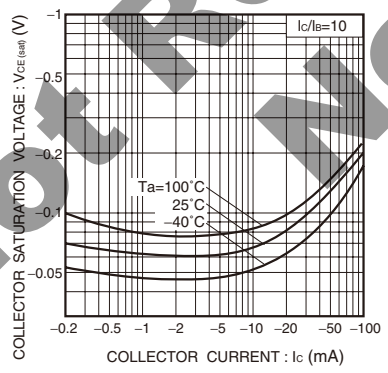

Fig.18 Collector-emitter saturation voltage vs. collector current (II)

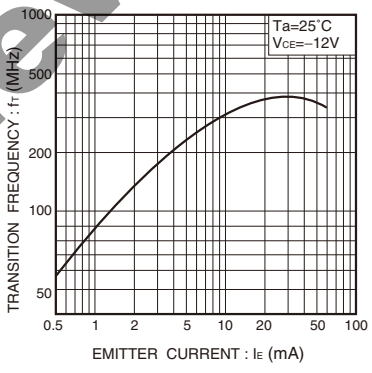

Fig.19 Gain bandwidth product vs. emitter current

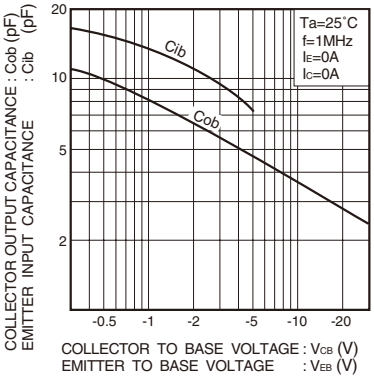

Fig.20 Collector output capacitance vs. collector-base voltage
Emitter input capacitance vs. emitter-base voltage

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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASSⅡb	CLASSⅢ
CLASSⅣ		CLASSⅢ	

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   [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
   [f] Sealing or coating our Products with resin or other coating materials
   [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
   [h] Use of the Products in places subject to dew condensation

4. The Products are not subject to radiation-proof design.

5. Please verify and confirm characteristics of the final or mounted products in using the Products.

6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.

8. Confirm that operation temperature is within the specified range described in the product specification.

9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.

2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
   [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
   [b] the temperature or humidity exceeds those recommended by ROHM
   [c] the Products are exposed to direct sunshine or condensation
   [d] the Products are exposed to high Electrostatic

2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.

3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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